

# Material Testing for SIGMASOFT

Douglas McMullen, Internal Sales Manager, Applus DatapointLabs



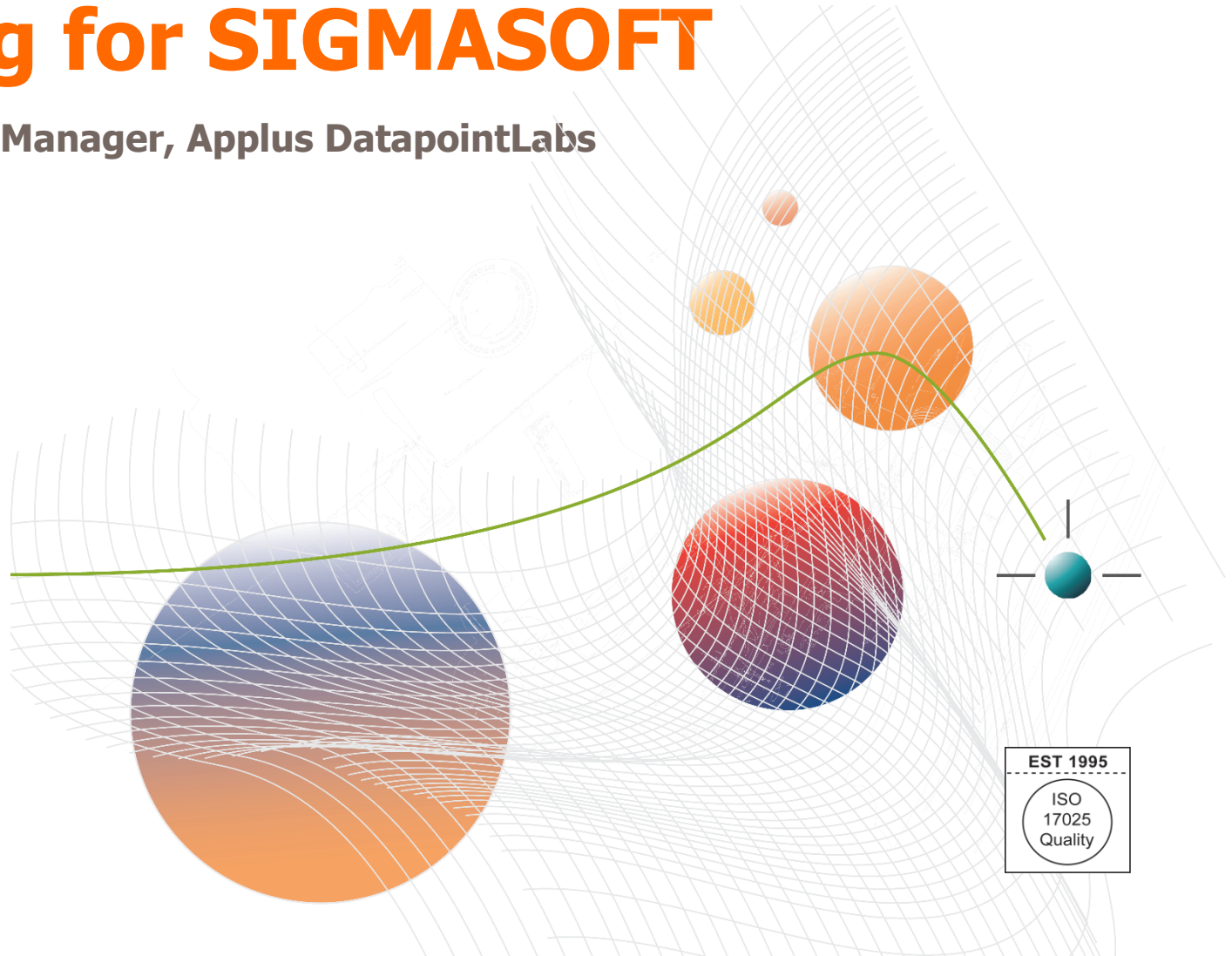
*TestCart*



*TestPaks*



*CAETestBench*








# Introduction to Applus

- **€1.778 billion total** revenue (2019)
- **23,000 staff** (2019)
- Present in more than **70 countries** across all continents
- Applus+ was on the Madrid Stock Exchange in May 2014

LABORATORIES DIVISION	IDIADA DIVISION	AUTOMOTIVE DIVISION	ENERGY & INDUSTRY DIVISION
<ul style="list-style-type: none"><li>• Testing</li><li>• Engineering</li><li>• Products &amp; Systems Certification</li><li>• Multidisciplinary Laboratories</li></ul>	<ul style="list-style-type: none"><li>• Design &amp; Engineering</li><li>• Testing</li><li>• Homologation services</li><li>• Proving ground</li></ul>	<ul style="list-style-type: none"><li>• Statutory vehicle inspection services for safety and emissions</li></ul>	<ul style="list-style-type: none"><li>• Industrial and environmental inspection</li><li>• Technical assistance</li><li>• Non-destructive testing (NDT)</li><li>• Technical staffing</li></ul>
			
Product Development & Validation		Vehicle In-Service	Asset design, construction and operation

# Laboratories Division- Scope of Services

Testing Services					
Structural Testing	Materials Characterization & Quality Assurance	EMC & Wireless	Fire Testing	IT Security & Interoperability	Metrology & Calibration
					
<ul style="list-style-type: none"><li>• Highest load Test accredited for Aero sector as independent Lab</li><li>• Fully accredited &amp; mainly focus in Aeronautical sector</li></ul>	<ul style="list-style-type: none"><li>• 6 Material Testing Laboratories in Europe, USA &amp; China</li><li>• Fully accredited Labs for Aeronautical Sector</li></ul>	<ul style="list-style-type: none"><li>• 3 State of the art laboratories in Europe</li></ul>	<ul style="list-style-type: none"><li>• Full Scale Fire Laboratory in Barcelona</li></ul>	<ul style="list-style-type: none"><li>• 3 Laboratories for product security evaluation and cybersecurity assessment in Spain and China</li></ul>	<ul style="list-style-type: none"><li>• Main focus in Spanish Local Market</li></ul>

# Laboratories Division- Scope of Products

## TEST RIGS AND TEST BENCHES FOR DEVELOPMENT

### Test Rigs & Tools



### HILs/SILs Virtual Testing



### Ground Test Equipment & Test Benches



### HILs/SILs Virtual Testing



## PRODUCTION EQUIPMENT

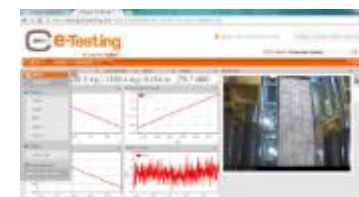
### Robotic NDT Equipment



### In-Line Measurement Machines



## SOFTWARE SOLUTIONS





# Applus+ Laboratories Division Sites



## Spain | Head Quarters

Multi-technological Testing Laboratories  
Engineering & Manufacturing  
Several Sites in Spain  
**Aerospace, Automotive, IT & Industry**

## NDT & NDT Equipment



**USA | Punta Gorda (FL)**  
Automated NDT Equipment  
Manufacturing  
**Aerospace**



**USA | Thallassee (AL)**  
NDT inspection for  
composites  
**Aerospace**

## EMC Laboratories



**UK | Silverstone**  
Electrical & Electronics  
**Automotive & Industry**



**Italy | Amaro (Udine)**  
Electrical & Electronics  
**Automotive & Industry**

## Fire Test Labs



**Spain | Asturias**  
Fire Safety in Tunnels  
**Infrastructures**



**Spain | Madrid**  
Product Fire Safety  
**Construction & Industry**



**Spain | Barcelona**  
Product Fire Safety  
**Chemicals, Oil & Gas**

## Metrology & Calibration Labs



### Spanish Network

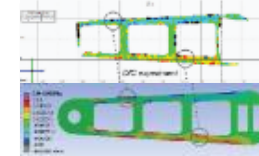
Barcelona  
Madrid  
Navarra  
A Coruña  
Albacete  
Sevilla

...

## Mechanical Test Laboratories



**France | St. Etienne**  
Mechanical & Materials  
**Aerospace & industry**



**USA | Ithaca (NY)**  
Materials Testing for  
Simulation & CAE  
**Aerospace & Industry**



**Spain | Illescas**  
Mechanical & Materials  
**Aerospace**



**Germany | Bremen**  
Mechanical & Materials  
**Aerospace & Industry**



**China | Shanghai**  
Mechanical & Materials  
IT payment systems  
**Aerospace & IT**



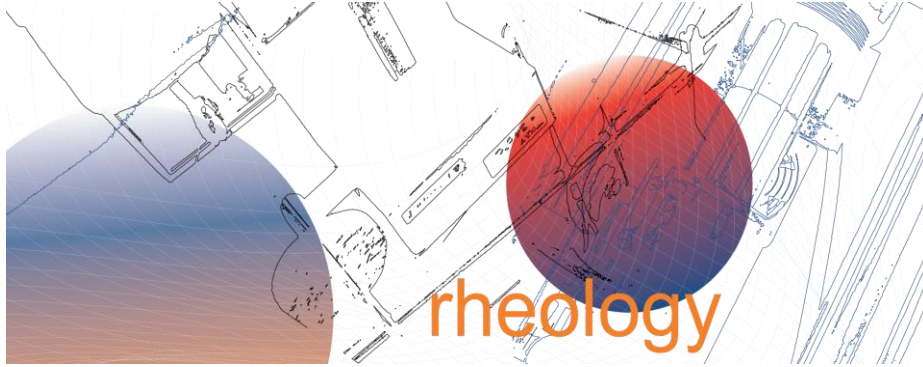
**Norway | Bryne (Stavenger)**  
Mechanical & Materials  
**Oil & Gas**



## *Thermoplastics*

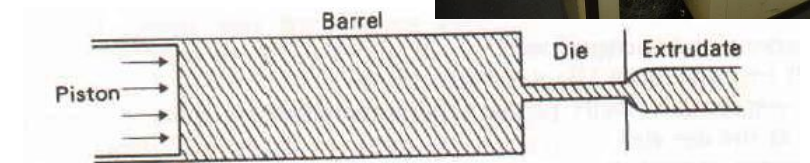
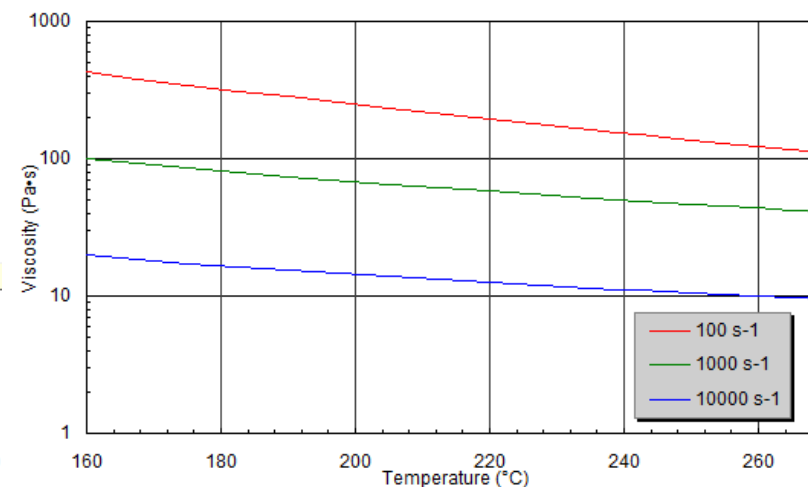
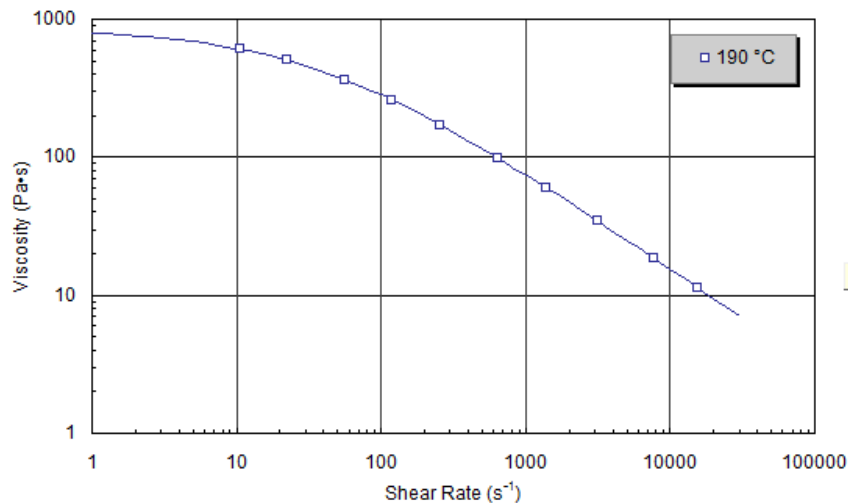
- Viscosity
- Specific Heat
- DSC Transition Temperature
- Thermal Conductivity
- PVT
- Linear Shrinkage
- Viscoelastic Properties

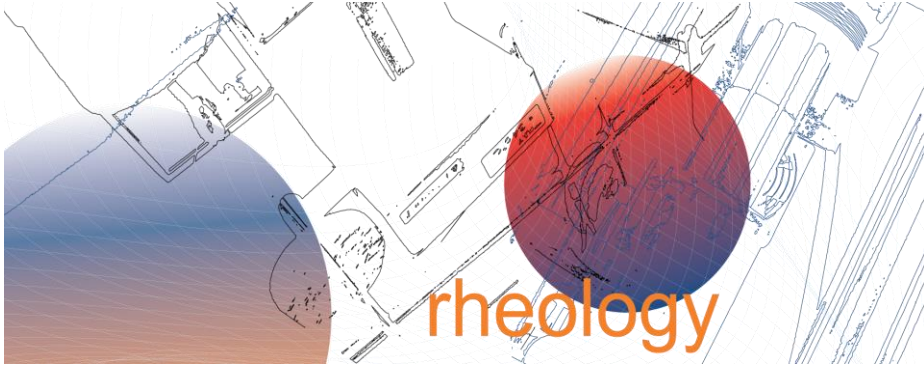
# Rheology



- Capillary viscosity
- Material is extruded through a restriction of known geometry (extremely high tolerance dies)
- Temperature and flow rate are controlled
- Pressure drop across the restriction is used to determine viscosity as a function of shear rate and temperature

- As shear rate increases, viscosity decreases
- As temperature increases, viscosity decreases





- Apparent Viscosity

- Shear rate:

$$\dot{\gamma}_a = \frac{32Q}{\pi d^3}$$

- Shear stress:

$$\tau_w = \frac{\Delta p d}{4L}$$

- Shear viscosity:

$$\eta_a = \frac{\tau_w}{\dot{\gamma}_a}$$

Where: Q = Volume flow rate

$\Delta p$  = Pressure drop

d = Capillary diameter

L = Capillary length

- Corrections to viscosity

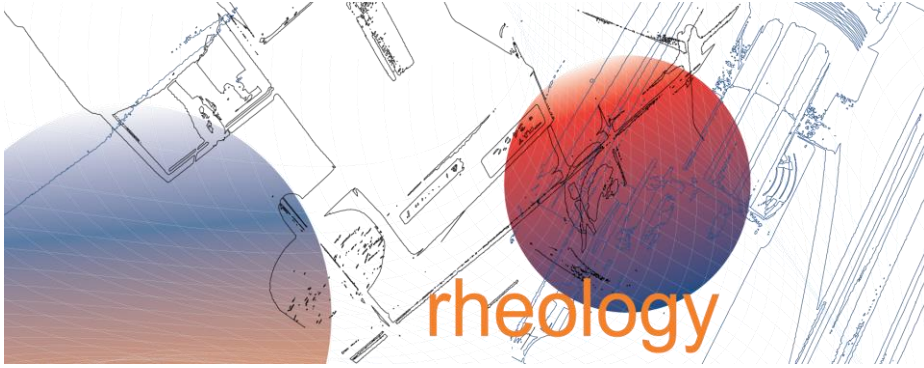
- Reservoir and friction losses (transducer located at die)

- End pressure drop (Bagley)

- Non-parabolic velocity (Rabinowitsch correction)

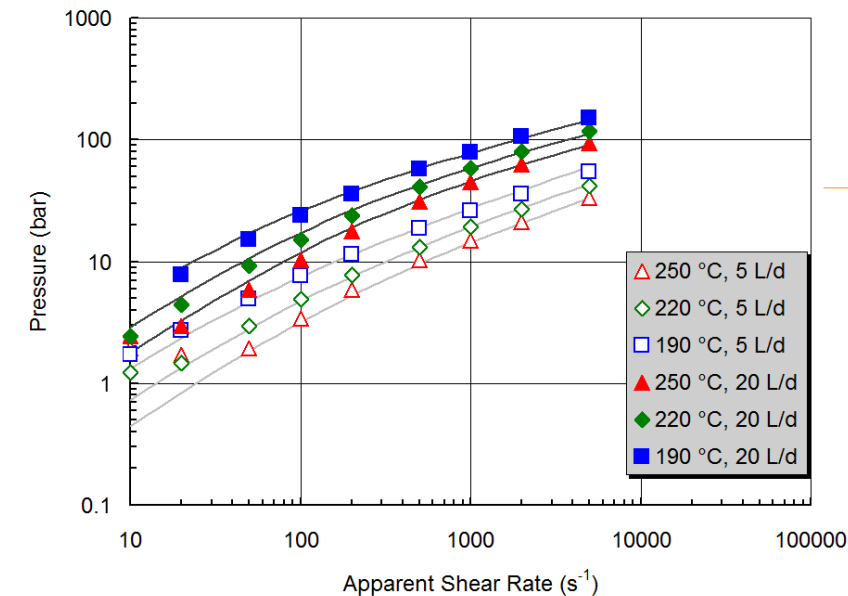


# Rheology

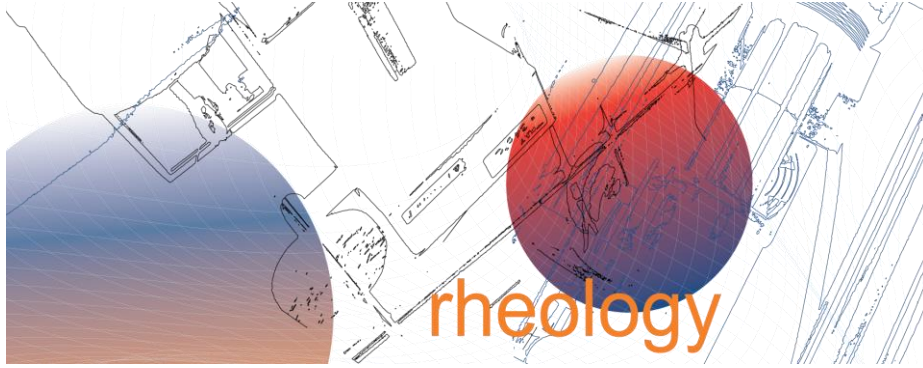


## • Bagley Correction Testing

- Perform viscosity measure on two different die ratios at equal shear rates
- Evaluate pressure differences between die geometries (capillary diameter remains the same)
- $\tau = R/2(dP/dL)$

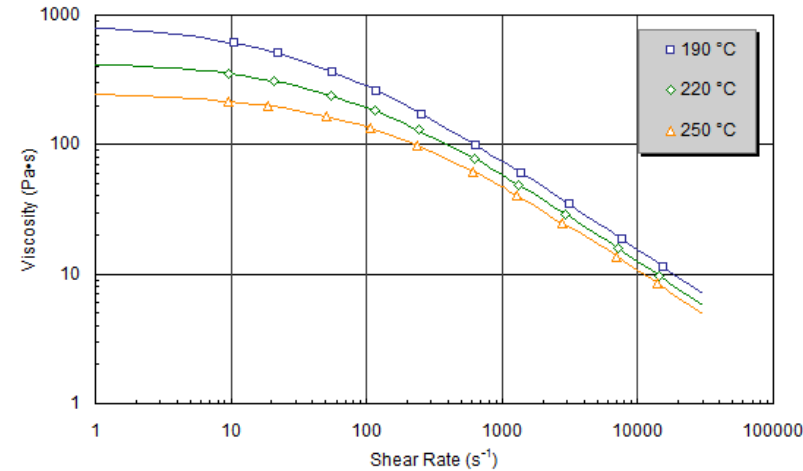


# Modeling



## •Viscosity Modeling

- Very strong rheological models
  - Cross WLF, Cross Arrhenius
- Combines a model of shear rate dependency with temperature dependency
- Allows us to predict beyond testing range



<b>n</b>	0.28400
<b>τ*</b>	32096.1
<b>D1</b>	3.86E+13
<b>D2</b>	263.15
<b>A1</b>	30.87
<b>A2</b>	51.6

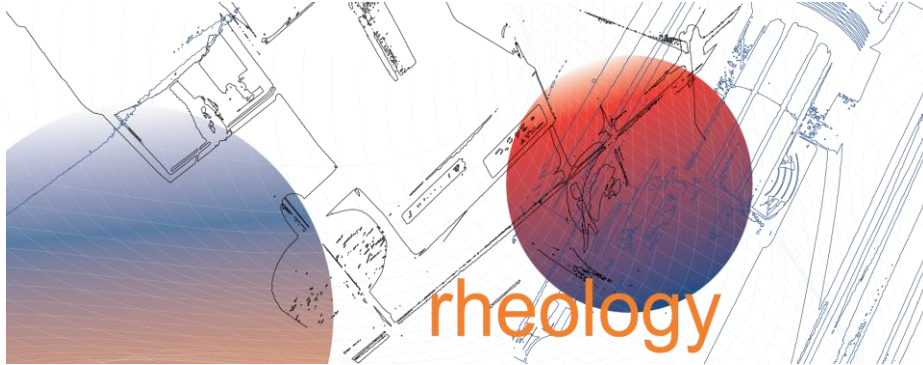
## •Evaluating Cross WLF Parameters

- The parameters are tied to real physical behavior
- N - measures shear thinning behavior
  - inverse of the power-law index
- rules for N
  - $0 < N < 1$
  - small N = shear sensitive
- $\tau^*$  is the critical transition stress for shear-thinning behavior
  - if  $\tau^*$  is large, wide Newtonian region
  - if  $\tau^*$  is small, narrow Newtonian region
  - $\tau^*$  is small for simple linear polymers
    - eg HDPE, LDPE, PP
  - $\tau^*$  is large for polymers with large side chains
    - eg. PC

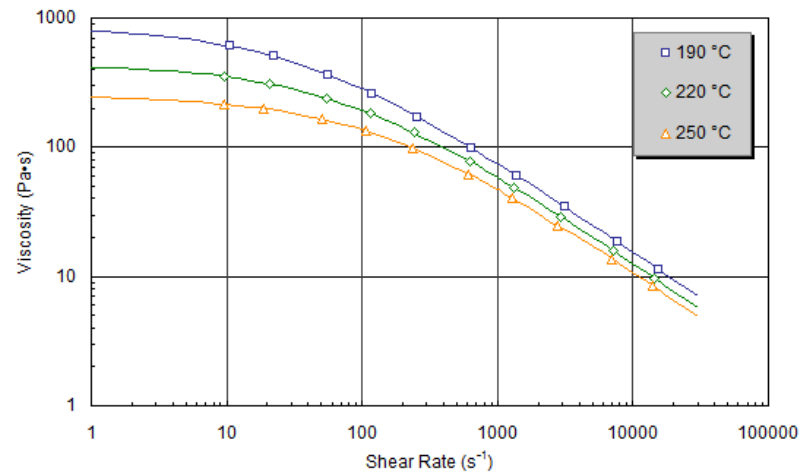
$$\eta(T, \dot{\gamma}) = \frac{\eta_0(T)}{1 + \left( \frac{\eta_0 \dot{\gamma}}{\tau^*} \right)^{1-n}}, \text{ where}$$

$$\eta_0(T) = D_1 \exp \left[ - \frac{A_1(T - D_2)}{A_2 + (T - D_2)} \right]$$

# Modeling



<b>n</b>	0.28400
<b><math>\tau^*</math></b>	32096.1
<b>D1</b>	3.86E+13
<b>D2</b>	263.15
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## •Evaluating Cross WLF Parameters

- D1 is coupled to the WLF temperature dependency equation

$$\eta(T, \dot{\gamma}) = \frac{\eta_0(T)}{1 + \left( \frac{\eta_0 \dot{\gamma}}{\tau^*} \right)^{1-n}}, \text{ where}$$

- No direct relevance

- D2 is the reference temperature

- Theoretically where h goes to infinity

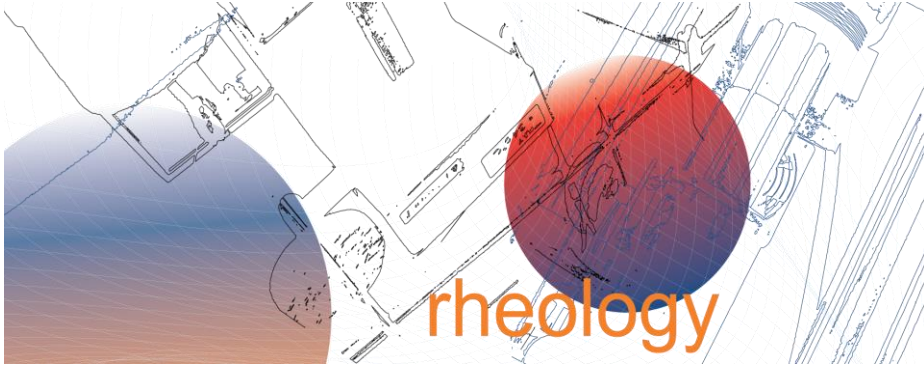
- A1 & A2 - WLF parameters

$$\eta_0(T) = D_1 \exp \left[ - \frac{A_1 (T - D_2)}{A_2 + (T - D_2)} \right]$$

- A1 defines the temperature sensitivity of viscosity

- A2 defines change in temperature sensitivity with temperature

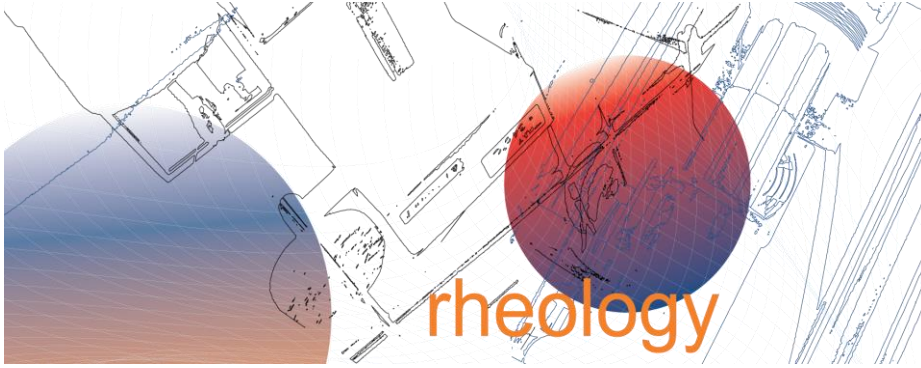
# Considerations for Testing



- Limited shear rates
  - Typically 10-10000 /s
  - Optional to go up to 100000 /s (uses smaller die)
- Residence times are longer in testing
  - Testing takes several minutes (approx. 6-10 min.)
  - Need to worry about thermal stability
- Processing temperatures are typically higher than test temperatures
- Typically testing is performed at two temperatures within the processing range and one below

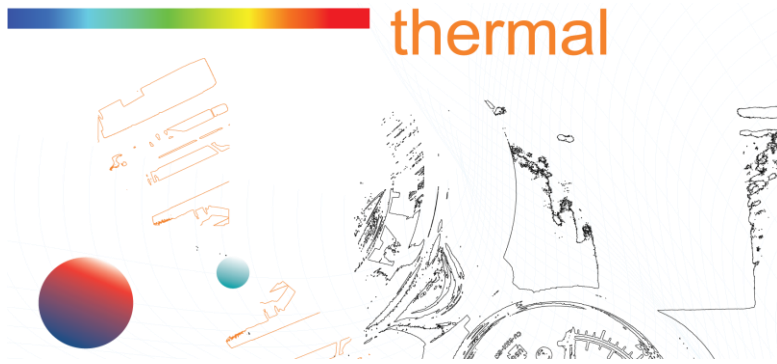


# Problematic Materials



- Moisture sensitive materials
  - Improperly dried materials cause reduction in viscosity
  - Over-dried materials cause a rise in viscosity
  - PET, PA, PC, PBT etc.
- Highly filled materials
  - Can “log jam” the die entrance
  - Special dies must be used
  - Higher scatter in test data requires engineering judgment on behavior
- Thermally unstable materials
  - Requires very careful attention to residence times
  - PVC

# Thermal Testing

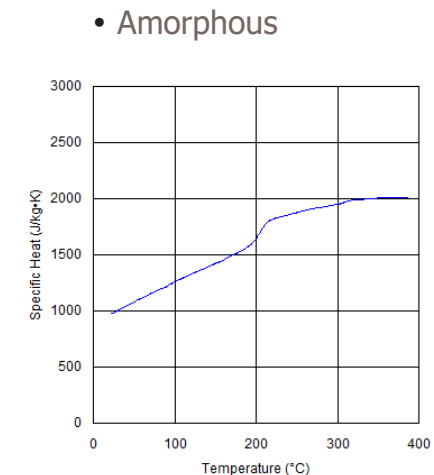
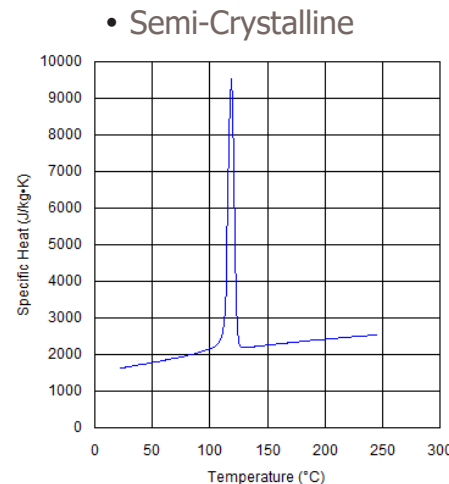


## • Specific Heat

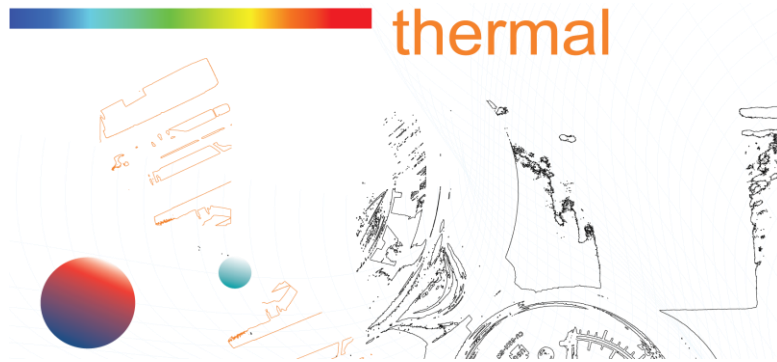
- DSC (Differential Scanning Calorimeter)
- Small samples sizes (7-15 mg)
- Differential heat required to raise the temperature of the sample as compared to a reference
- Performed in cooling to replicate molten material cooling to solidification
- Used in the simulation to determine how much energy must be dissipated to promote solidification

## • Transition Analysis

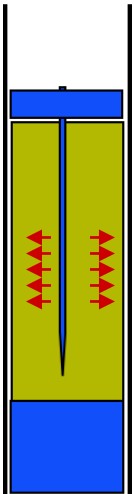
- Semi-Crystalline materials show a peak in the specific heat curve
  - The peak is due to the addition heat needed to initiate crystallization
  - Due to thermal lag, transition temperatures measured in cooling mode will be lower than those measured in heating
  - The onset of the transition is set as the melting point to ensure complete melt of the polymer
  - The point at which the peak ends is set as the eject temperature
  - Beyond the eject temperature, no flow can take place
- Amorphous materials show a “knee” in the specific heat curve
  - The knee is the glass transition of the material, no crystallization takes place
  - The onset of the transition is set as the melting point to ensure complete melt of the polymer
  - In this case the inflection point of the knee is taken as the eject temperature
  - Beyond the eject temperature, no flow can take place



# Thermal Testing

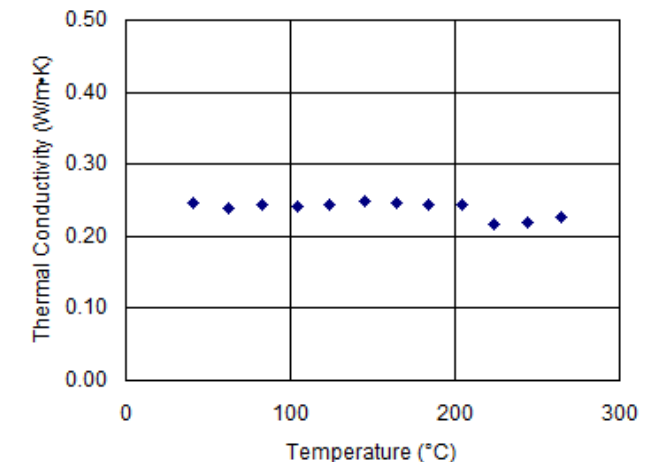


- Measure time to dissipate the heat pulse away from probe

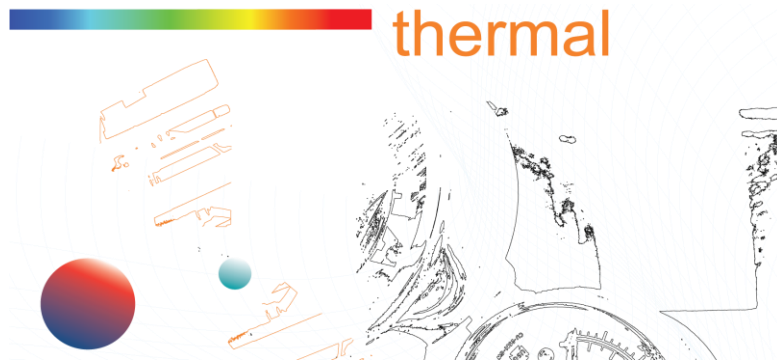


## • Thermal Conductivity

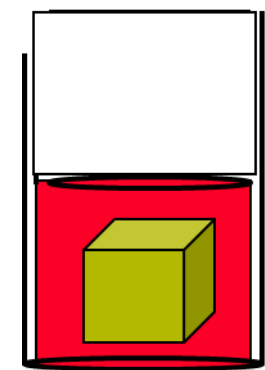
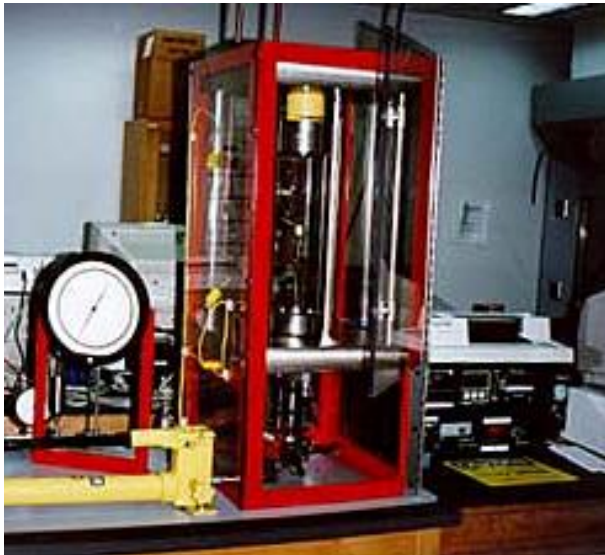
- A measure of how well a material transfers heat
  - Measured using transient line source
  - Measured in melt and solid state
  - Different behaviors for semi-crystalline and amorphous
  - Semi-crystalline materials show an increase in thermal conductivity in solid state
  - Amorphous materials show a decrease in thermal conductivity in solid state
  - The addition of fillers increase thermal conductivity
- Thermal conductivity of polymers is much lower than metals
  - Copper: 400 W/mK
  - ABS: 0.176 W/mK



# PVT (pressure, volume and temperature)

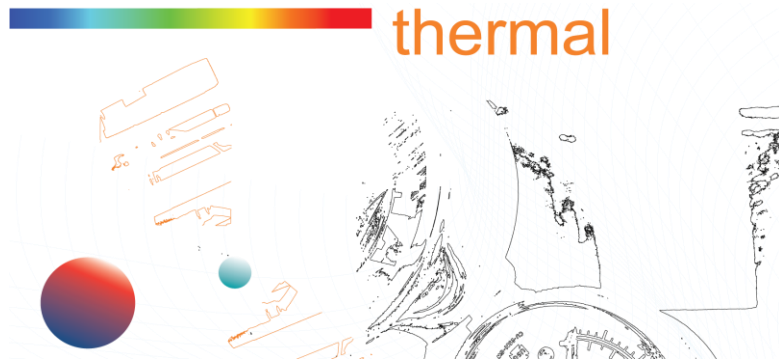


- Isobaric cooling (for semi-crystalline materials)
  - Need to accurately capture the onset of crystallization
  - Much longer run times
- Isothermal heating scan (for amorphous materials)
  - No crystallization so transition is independent of mode
  - Much faster (relatively)
- Pressures of 10 – 200 Mpa
- Measure both solid and melt domains
- Difficult and time-consuming test
  - Initial density at ambient conditions
  - Mercury used as confining fluid
  - High temperatures and pressures
  - Complex datasets
  - True hydrostatic state

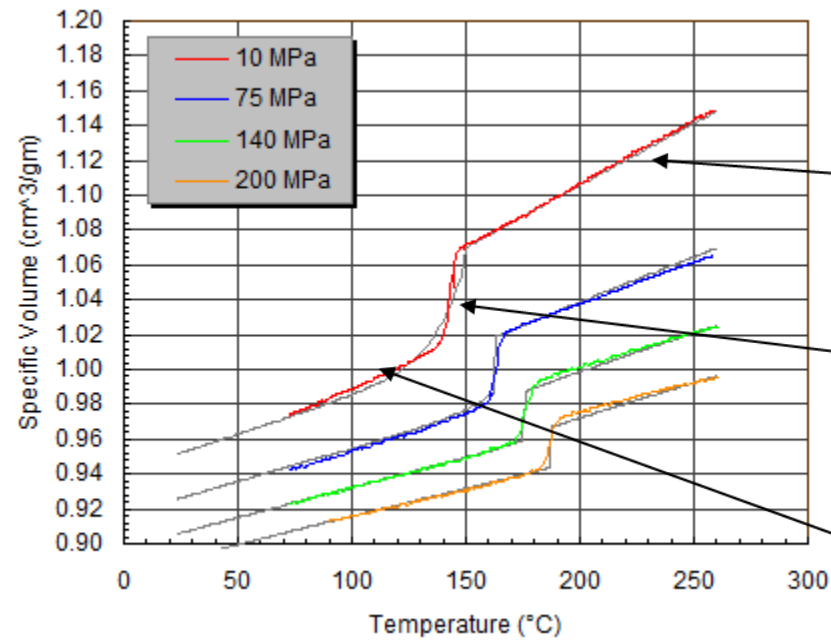




# PVT (pressure, volume and temperature)



- Semi-Crystalline material
  - Transition region is critical
  - Rise in temp. = rise in spec. vol.
  - Rise in press. = drop in spec. vol.



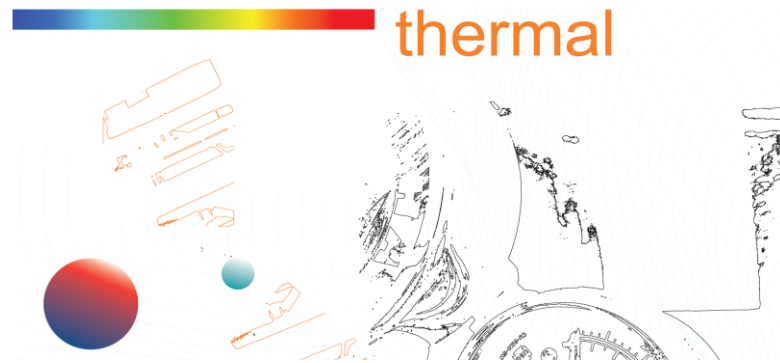
Molten

Transitional

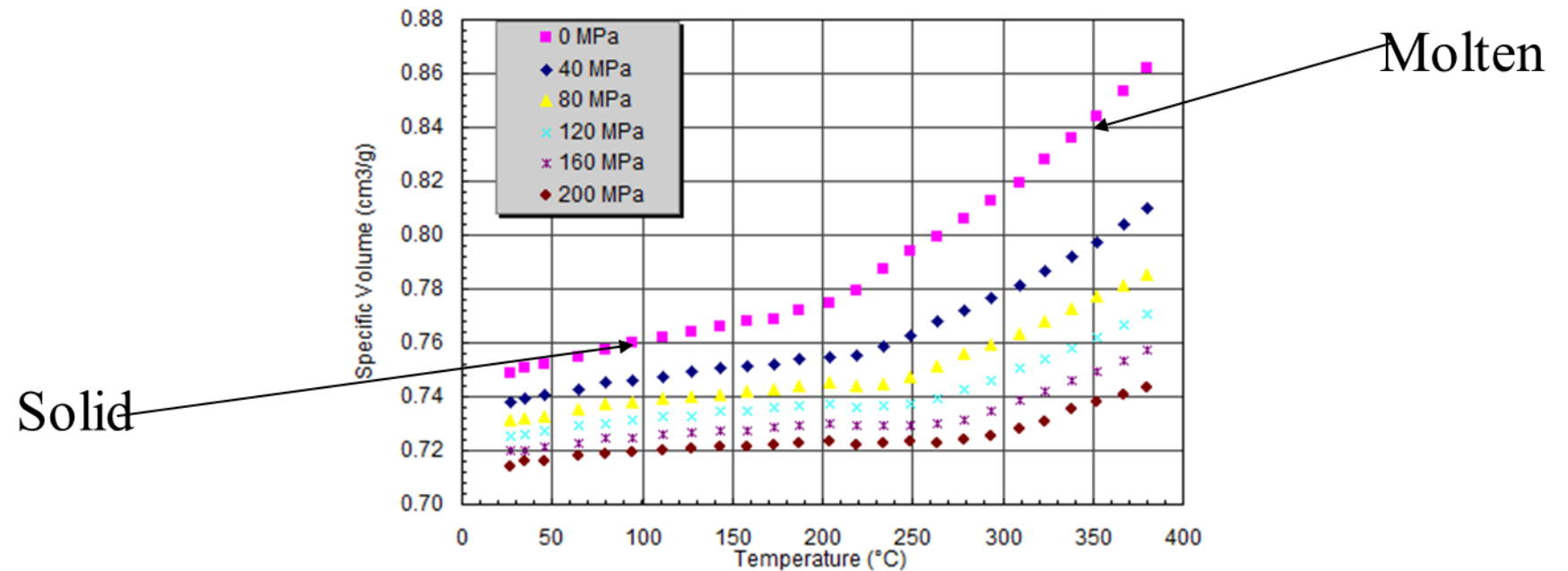
Solid



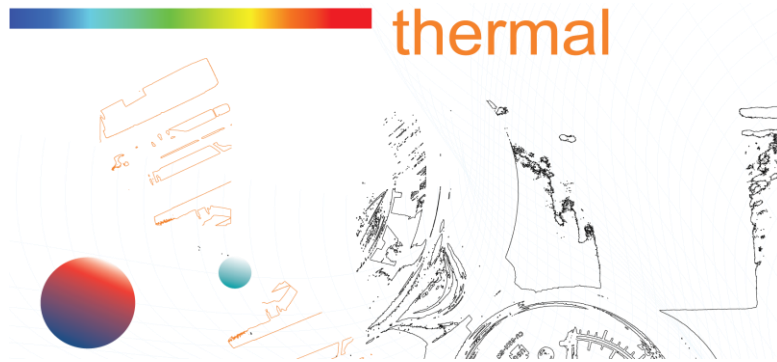
# PVT (pressure, volume and temperature)



- Amorphous material
- Transition is not dependent on mode



# Modeling



## • Two domain Tait model

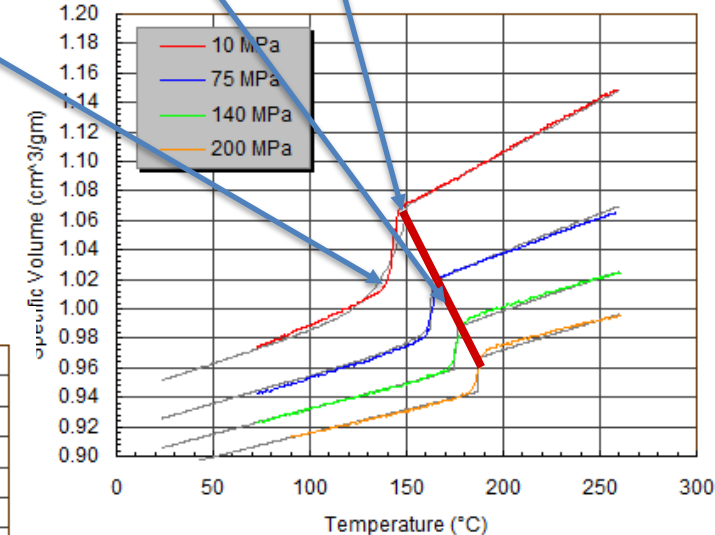
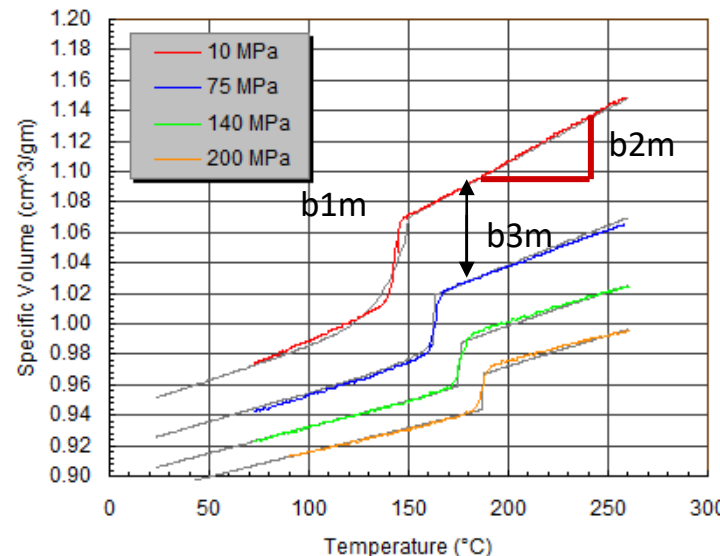
- b1m is the specific volume at b5
- b2m is the slope of the melt region
- b3m is the pressure sensitivity or spread of the melt fit
- b4m is the pressure sensitivity of the melt state slope
- b1s through b4s are the same but for the solid state

## • Two domain Tait model (transition region)

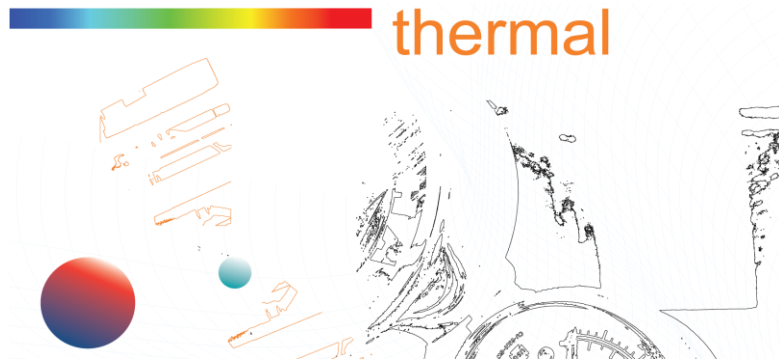
- 13 parameters
- Three groups of parameters
  - b5 is the transition of the low pressure
  - b6 is the slope of the transition
  - b7, b8, and b9 describe the shape of the crystalline transition

Two-Domain Tait PVT Model:

b5	4.202E+02 K
b6	2.000E-07 K/Pa
b1m	1.081E-03 m <sup>3</sup> /kg
b2m	7.707E-07 m <sup>3</sup> /kg•K
b3m	6.864E+07 Pa
b4m	3.209E-03 1/K
b1s	1.011E-03 m <sup>3</sup> /kg
b2s	4.442E-07 m <sup>3</sup> /kg•K
b3s	1.397E+08 Pa
b4s	1.752E-03 1/K
b7	7.064E-05 m <sup>3</sup> /kg
b8	8.027E-02 1/K
b9	4.311E-08 1/Pa



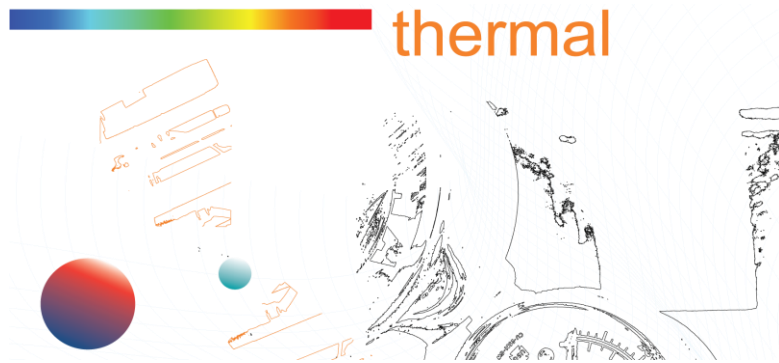
# Problematic Materials



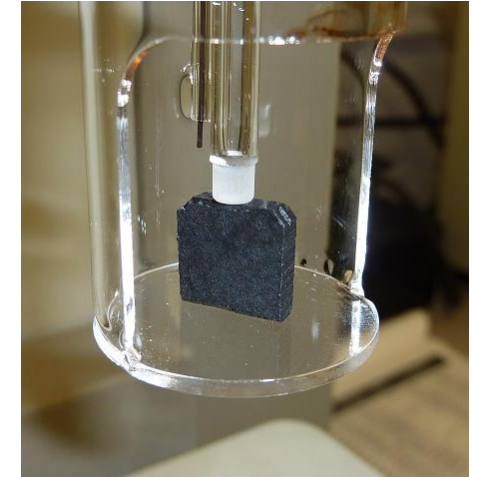
- Thermally unstable materials
- Materials that have voids
- Very high melting point materials
  - Limitation of machine is 400°C
  - Mercury boils at 356°C under atmospheric conditions (test at minimum of 10 MPa)
  - PEI, PAEK



# Thermal Expansion



- TMA (Thermo-Mechanical Analyzer)
  - 10 x 10 mm x thickness plaques
  - Low expansion quartz probe and station
  - Constant heating rate
  - Slope of  $\delta L$  over temperature
- Orientation
  - One direction for no fiber
  - Two directions for fiber filled



- Data presented as calculated slopes that are constant over the test range
- Plot of probe position vs. temperature ensures linear relationship
- Anisotropic materials
- Measurements across the flow always higher
- Fibers have less thermal expansion than polymer

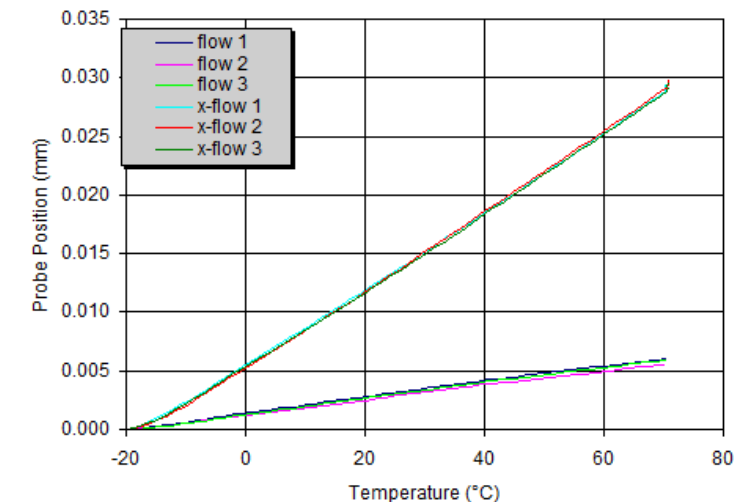
## CLTE

### flow direction ( $\alpha_1$ )

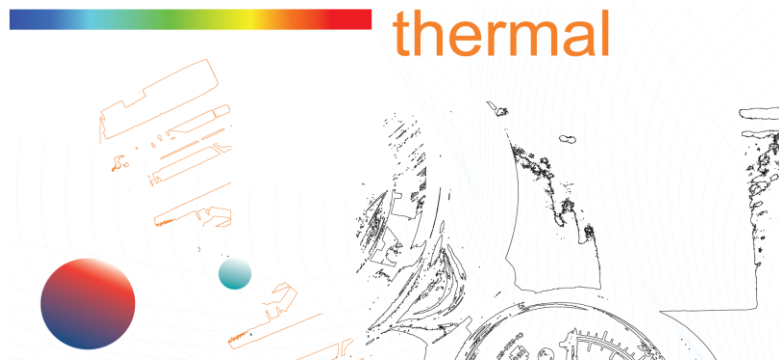
	0° to 60°C
replicate 1	6 x 10 <sup>-6</sup> / °C
replicate 2	6 x 10 <sup>-6</sup> / °C
replicate 3	6 x 10 <sup>-6</sup> / °C
average	6 x 10 <sup>-6</sup> / °C

### cross-flow direction ( $\alpha_2$ )

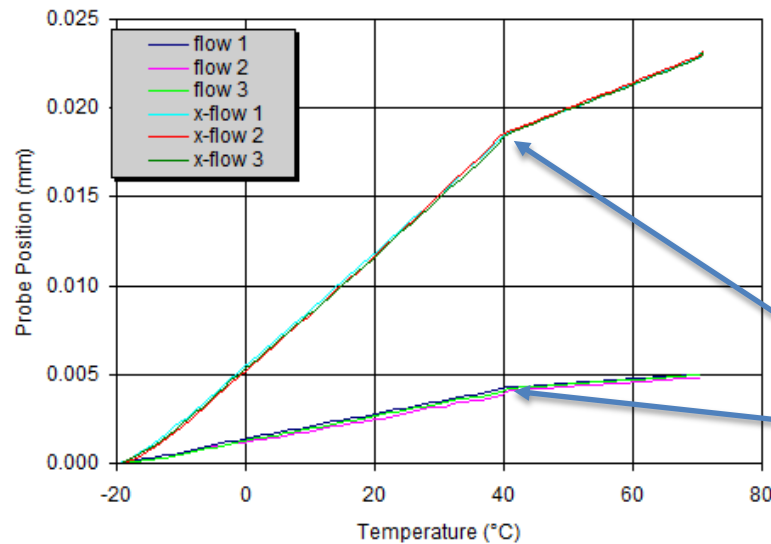
	0° to 60°C
replicate 1	34 x 10 <sup>-6</sup> / °C
replicate 2	33 x 10 <sup>-6</sup> / °C
replicate 3	31 x 10 <sup>-6</sup> / °C
average	33 x 10 <sup>-6</sup> / °C



# Problematic Materials



- Continuous fiber materials
  - Test probe sits directly on the fibers that have similar CLTE to probe
- Residual stress after molding
  - Require additional annealing operation to alleviate stresses
- Very soft materials
  - Probe penetrates sample
- Films
  - Special test methods are required
  - Tend to show shrinkage due to processing method

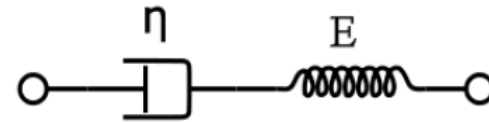


In mold stresses

# Mechanical Testing

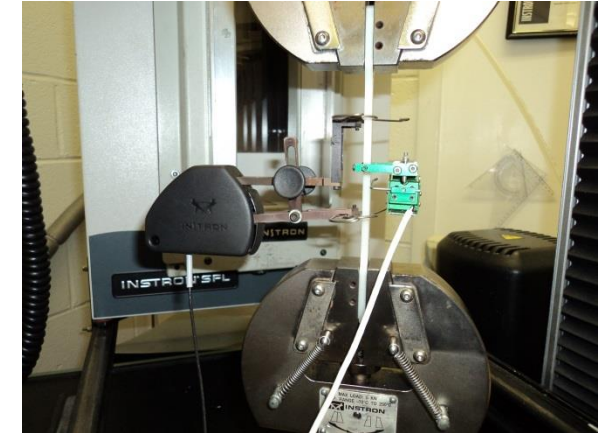
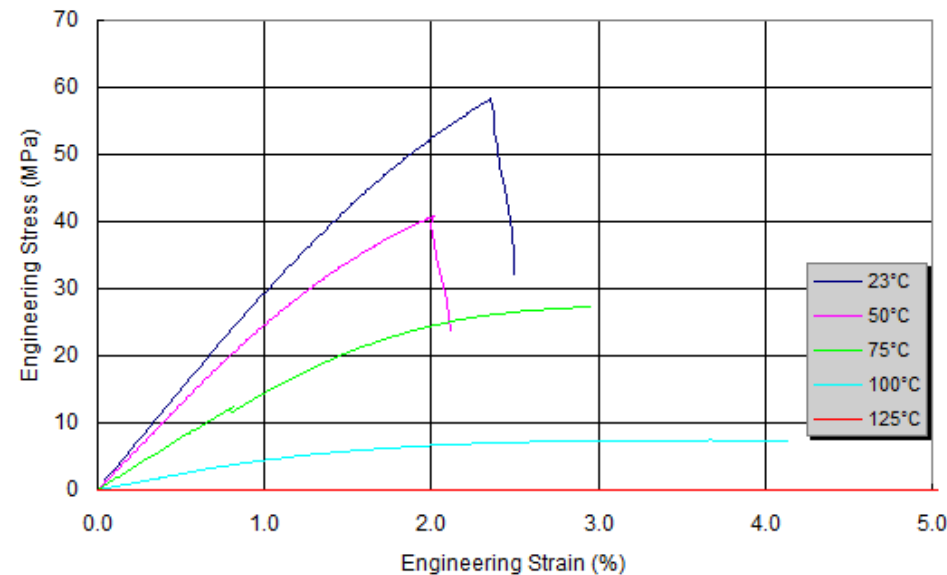


- Only valid for unfilled materials
- Performed at constant strain rate
  - Converted to relaxation times
  - Multi-temperature allows for temperature dependent relaxation



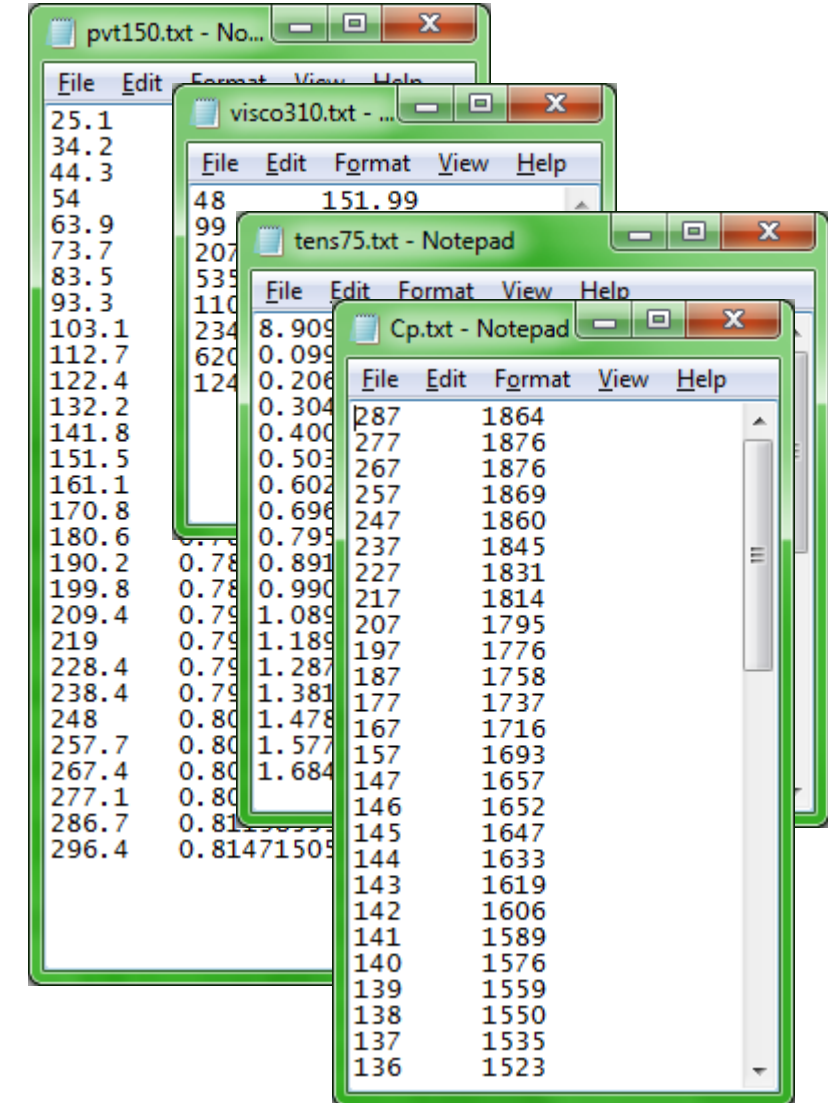
## Properties

Temp. °C	Modulus E MPa	Poisson's Ratio
23	3010	0.372
50	2564	0.390
75	1555	0.426
100	480	0.465
125	2	0.480



# Implementation into SIGMASOFT

- X-Y pairs in text files
- Viscosity (3)
- Specific heat (1)
- Thermal conductivity (1)
- PVT (4-6)
- CTE (1)
- Mechanicals (5)
- At least 17 input files



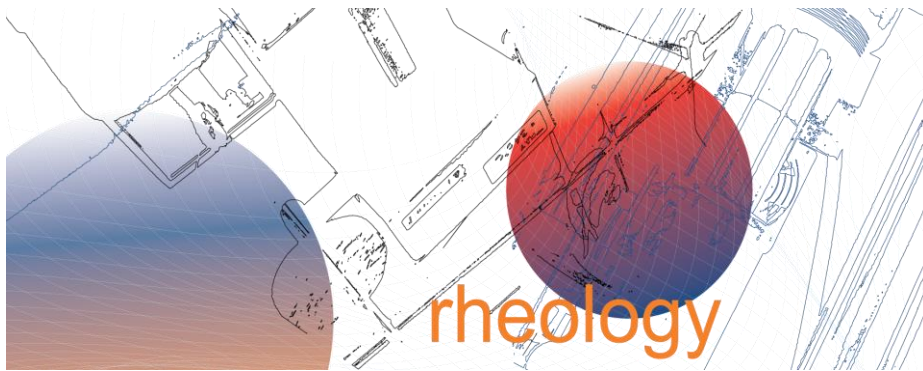




## *Thermoset/Rubber*

- Viscosity
- Curing Viscosity
- Specific Heat
- Thermal Conductivity
- PVT

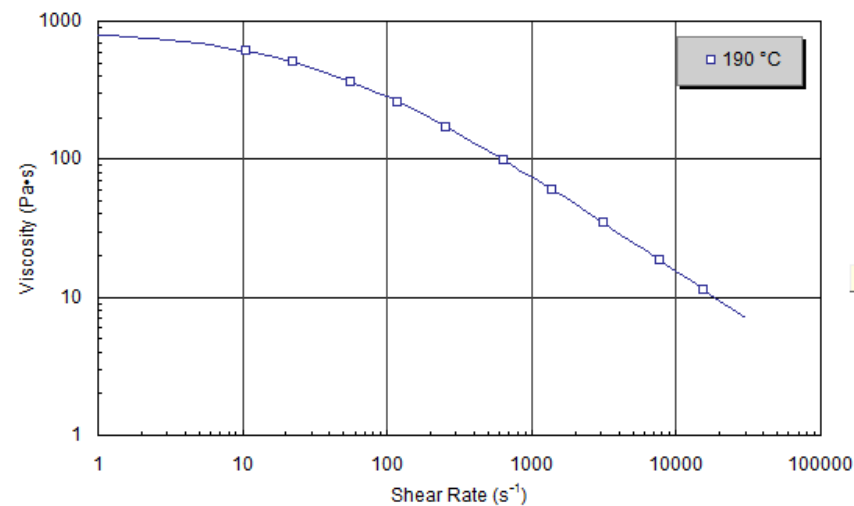
# Rheology



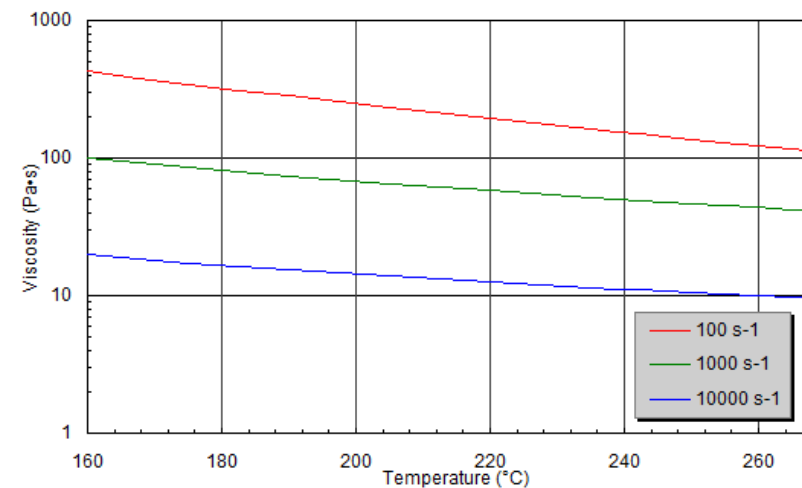
- Capillary viscosity for rubber
- Parallel plate rheometer for liquids
- Material is extruded through a restriction of known geometry (extremely high tolerance dies)
- Lower plate oscillates while top records torque
- Must be done on non-curable material or well below cure temperature



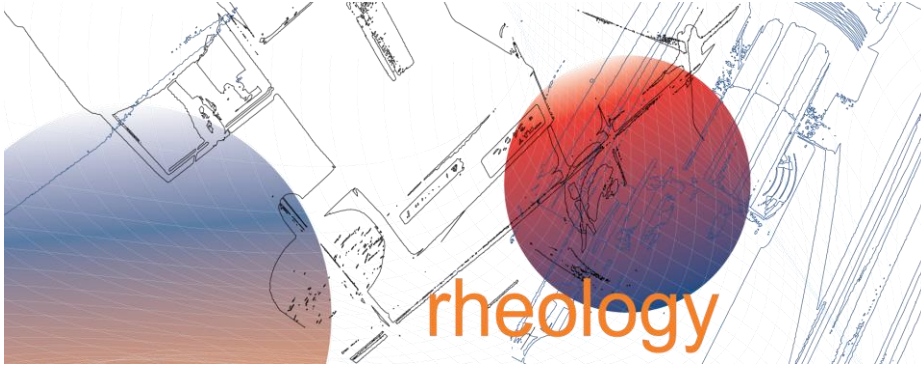
- As shear rate increases, viscosity decreases



- As temperature increases, viscosity decreases

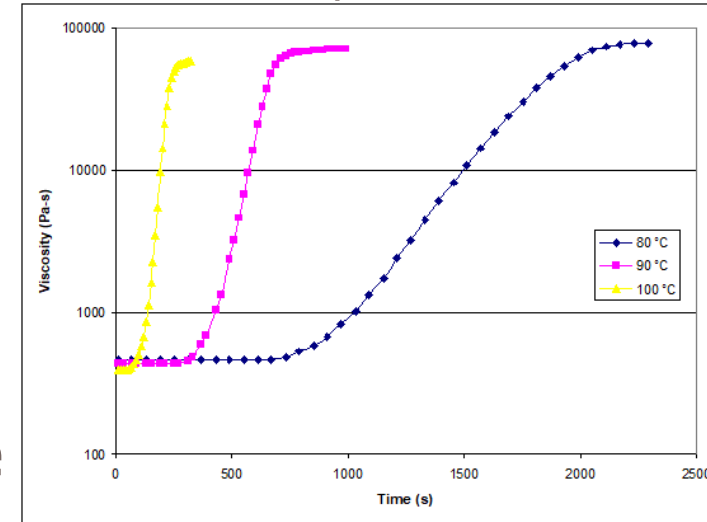


# Rheology (Curing)

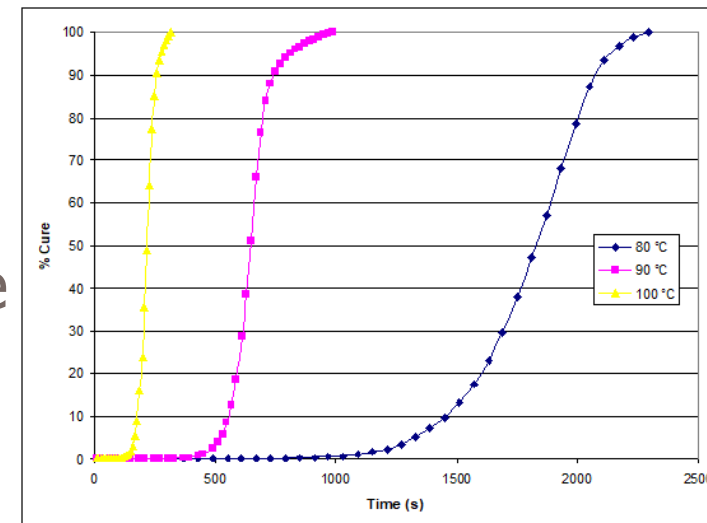


- Capture viscosity vs. temperature and time
- Isothermal time sweeps
  - 3 temperatures
  - Continue until plateau
- Calculate % cure relative to initial viscosity
- May have to eliminate initial negative slope
  - Can't have negative cure

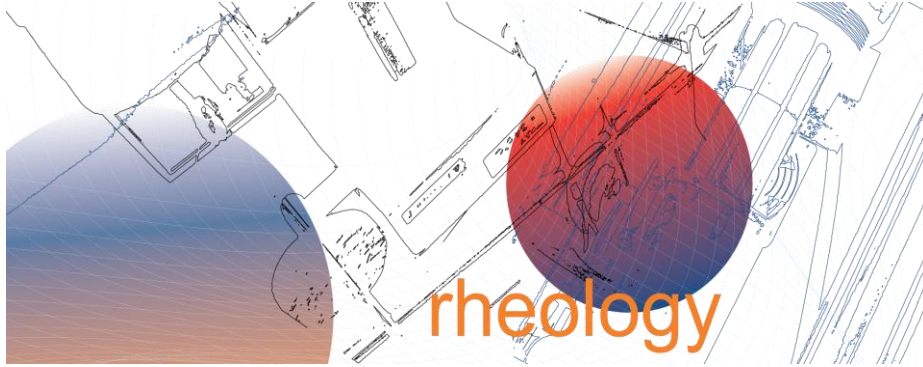
• Viscosity vs. Time



• Cure vs. Time

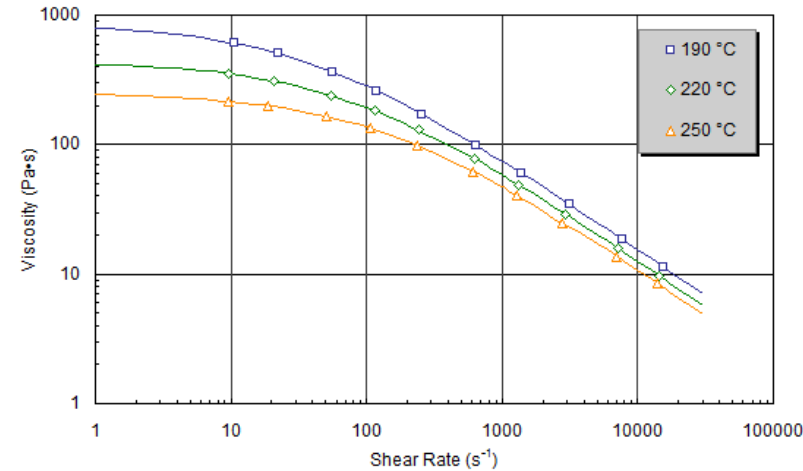


# Modeling



## •Viscosity Modeling

- Very strong rheological models
  - Cross WLF, Cross Arrhenius
- Combines a model of shear rate dependency with temperature dependency
- Allows us to predict beyond testing range



<b>n</b>	0.28400
<b>τ*</b>	32096.1
<b>D1</b>	3.86E+13
<b>D2</b>	263.15
<b>A1</b>	30.87
<b>A2</b>	51.6

## •Evaluating Cross WLF Parameters

- The parameters are tied to real physical behavior
- N - measures shear thinning behavior
  - inverse of the power-law index

$$\eta(T, \dot{\gamma}) = \frac{\eta_0(T)}{1 + \left( \frac{\eta_0 \dot{\gamma}}{\tau^*} \right)^{1-n}}, \text{ where}$$

- rules for N
  - $0 < N < 1$
  - small N = shear sensitive
- $\tau^*$  is the critical transition stress for shear-thinning behavior
  - if  $\tau^*$  is large, wide Newtonian region
  - if  $\tau^*$  is small, narrow Newtonian region
  - $\tau^*$  is small for simple linear polymers
    - eg HDPE, LDPE, PP
  - $\tau^*$  is large for polymers with large side chains
    - eg. PC

$$\eta_0(T) = D_1 \exp \left[ - \frac{A_1(T - D_2)}{A_2 + (T - D_2)} \right]$$

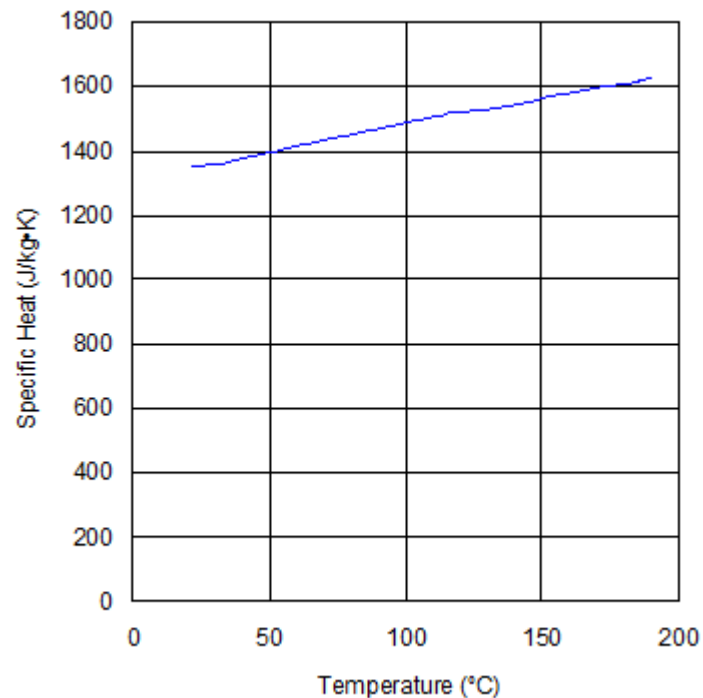
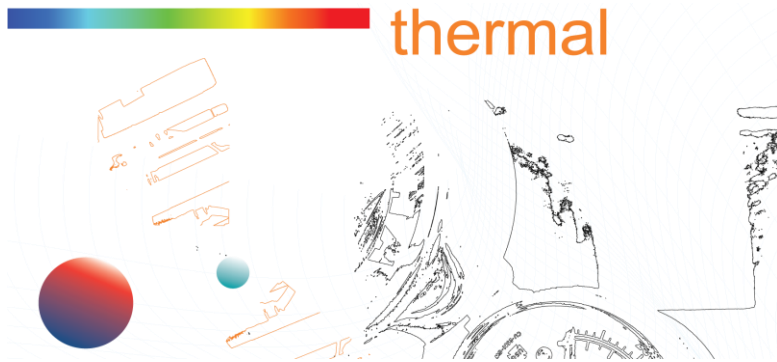
# Problematic Materials

- Materials that are not liquid
  - Require high pressures
  - Reaction starts while melting
  - BMC (bulk molding compounds)
- Highly filled materials
  - Very long fibers are too long for fixtures
  - Cannot get a homogeneous sample
  - SMC
- Very fast reaction materials
  - cyanoacrylates
- UV cure materials
  - PU
- Reaction injection molding
- Foaming materials





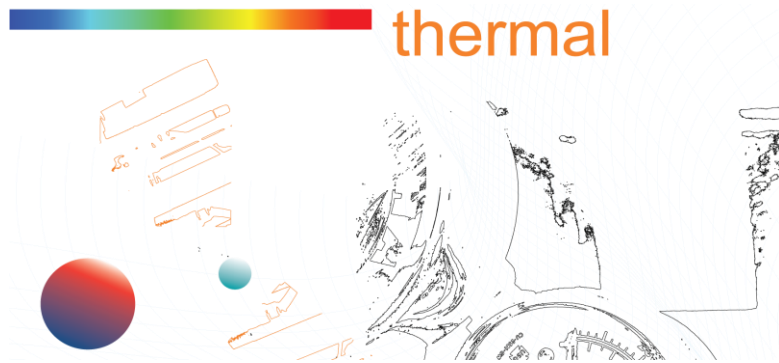
# Thermal Testing



## • Specific Heat

- DSC (Differential Scanning Calorimeter)
- Small samples sizes (7-15 mg)
- Performed in cooling to eliminate the curing enthalpy peak
- Enthalpy of reaction is recorded in the heating phase to but is not included in the specific heat curve.
- Some materials do not show an enthalpy peak or the peak is very small.
- The reaction peak is used to set the upper temperature for the PVT test
- Problems can arise if the material is strongly exothermic

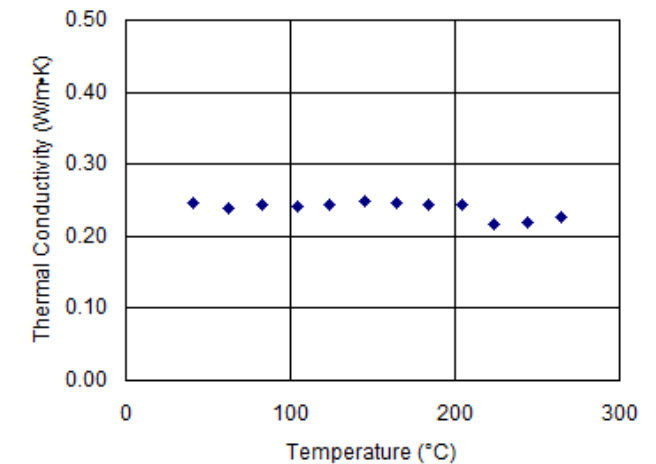
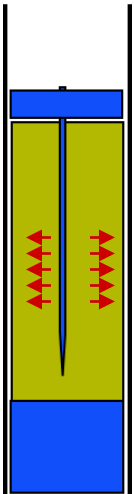
# Thermal Testing



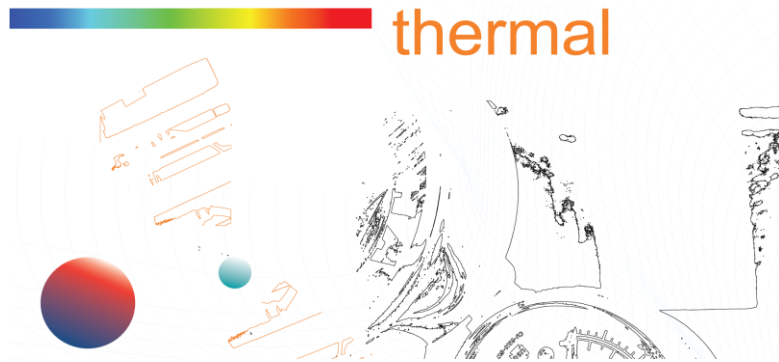
## • Thermal Conductivity

- A measure of how well a material transfers heat
  - Measured using transient line source
  - Unlike thermoplastics, the test is run from room temperature up to cure temperature
  - The barrel must be coated with silicone to prevent adhesion
  - Since the test relies on heat diffusion, exothermic material pose a problem

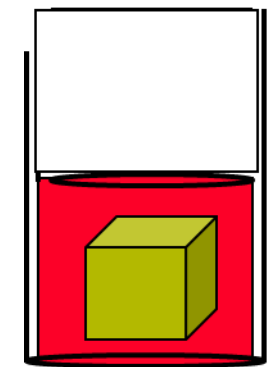
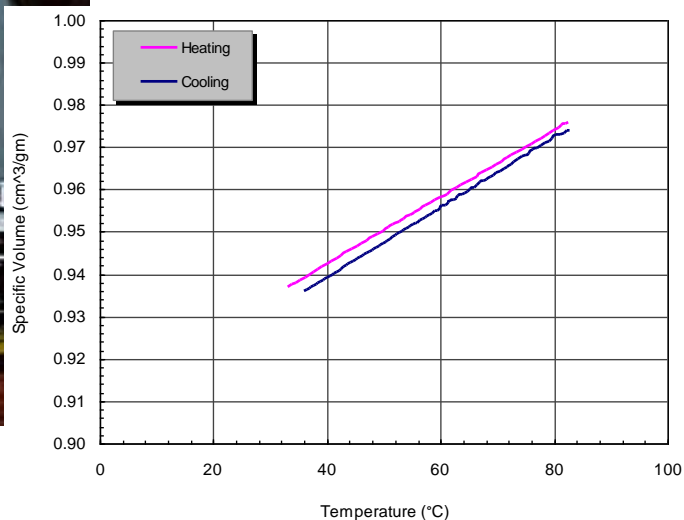
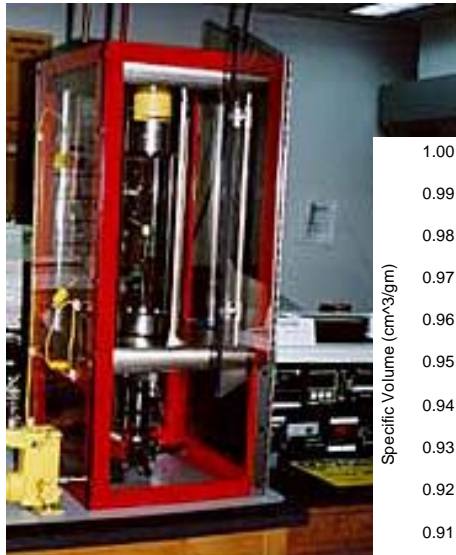
- Measure time to dissipate the heat pulse away from probe



# PVT (pressure, volume and temperature)



- Isobaric heating
  - Start with an uncured sample
  - Heat to just below cure temperature
  - Hold for up to two hours
  - Ensure full reaction has taken place
  - Cool back to start temperature
- The initial heat is the volumetric expansion due to heat and reaction
- The cooling is the volumetric expansion due to only thermal effect
- Cannot be done on materials the have a large amount of out-gassing
- Cannot be done on materials that begin to react as soon as they are mixed (setup time is very long)
- Can be done at multiple pressures but often not needed



expert material testing

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